



Designation: B281 – 88 (Reapproved 2019)^{ε1}

Standard Practice for Preparation of Copper and Copper-Base Alloys for Electroplating and Conversion Coatings¹

This standard is issued under the fixed designation B281; the number immediately following the designation indicates the year of original adoption or, in the case of revision, the year of last revision. A number in parentheses indicates the year of last reapproval. A superscript epsilon (ϵ) indicates an editorial change since the last revision or reapproval.

This standard has been approved for use by agencies of the U.S. Department of Defense.

^{ε1} NOTE—The name and designation of the ASTM standard cited in 2.1 and Note 3 were updated editorially in May 2019.

1. Scope

1.1 This practice is intended to serve as a guide for the proper preparation of copper and its alloys for electroplating and conversion coating. This practice is also suitable for use before autocatalytic plating. Only alloys containing at least 50 mass % copper are considered within the scope of this practice.

1.2 The wide variety of methods of mechanical finishing are not considered strictly as preparation for electroplating or conversion coating and consequently are described only briefly.

1.3 Details of electroplating and subsequent treatments for applying conversion coatings are not within the scope of this practice.

1.4 *This standard does not purport to address all of the safety concerns, if any, associated with its use. It is the responsibility of the user of this standard to establish appropriate safety, health, and environmental practices and determine the applicability of regulatory limitations prior to use.* For a specific hazard statement, see 6.5.2.

1.5 *This international standard was developed in accordance with internationally recognized principles on standardization established in the Decision on Principles for the Development of International Standards, Guides and Recommendations issued by the World Trade Organization Technical Barriers to Trade (TBT) Committee.*

2. Referenced Documents

2.1 *ASTM Standards*:²

B322 Guide for Cleaning Metals Prior to Electroplating

¹ This practice is under the jurisdiction of ASTM Committee B08 on Metallic and Inorganic Coatings and is the direct responsibility of Subcommittee B08.02 on Pre Treatment.

Current edition approved April 1, 2019. Published May 2019. Originally approved in 1953. Last previous edition approved in 2013 as B281 – 88(2013). DOI: 10.1520/B0281-88R19E01.

² For referenced ASTM standards, visit the ASTM website, www.astm.org, or contact ASTM Customer Service at service@astm.org. For *Annual Book of ASTM Standards* volume information, refer to the standard's Document Summary page on the ASTM website.

3. Significance and Use

3.1 The proper preparation of copper and copper alloy surfaces for electroplating, conversion coating, or autocatalytic plating is often critical to the performance of the coatings.

3.2 This practice outlines procedures required to produce satisfactory coatings on surfaces of copper and copper alloy surfaces.

4. Process Chemicals

4.1 All process chemicals are of technical grade or better. Acid solutions are prepared from grade chemicals as listed in **Appendix XI**.

4.2 *Purity of Water*—High quality water is not normally required to make up and maintain the solutions utilized in this practice. If reused or recycled water from waste treatment processes or from other in-plant sources is to be used, it should be relatively free of chromium salts, oil, wetting agents, or insoluble materials. Excessively hard water can decrease the life and performance of many cleaning solutions and make parts more difficult to rinse completely.

5. General Considerations

5.1 *Removal of Oxides*—Oxides can be removed from as fabricated, annealed, or heat-treated alloys by abrasive methods such as tumbling, burnishing, and emery set-up wheel polishing and by chemical methods, such as deoxidizing solutions, bright dips, and cyanide dips. The choice of method is dependent on the resultant surface finish required, amount of oxide to be removed, and the end-use properties of the article finished.

5.2 *Castings and Forgings*—Castings and forgings requiring abrasive methods to produce a desired surface finish do not necessarily need pickling or bright dipping. If pickled, bright dipped, or deoxidized, however, castings and other porous parts should be thoroughly rinsed between operations to avoid or minimize staining or stain spots. Castings or forgings processed in solutions containing wetting agents, which are in

many proprietary products or which may be added by the individual, usually require greater care in rinsing.

5.3 Stampings and Drawn Products—Stampings and drawn work follow the same rule as castings and forgings except, for economy considerations, it may be advisable to pickle or deoxidize before abrasive finishing if heavy oxides are present.

5.4 Cold-Headed and Progressive Die Products—Cold-headed products and progressive die products often require relief annealing to avoid subsequent season cracking.

5.5 Screw Machine Products—Screw machine products may be readily electroplated with only mild cleaning and acid dipping as they are produced from the machines. Abrasive methods may be applied as appropriate before cleaning and acid dipping.

6. Preparation for Electroplating and Conversion Coating

6.1 Outlines of Typical Preparatory Cycles:

6.1.1 Vapor degrease or alkaline clean or emulsion soak clean, or tumble clean,

6.1.2 Rinse,

6.1.3 Alkaline electroclean,

6.1.4 Rinse,

6.1.5 Acid dip,

6.1.6 Rinse, and

6.1.7 Electroplate or conversion coat in an acid solution.

NOTE 1—A bright dip, electropolish, or deoxidization may be added after step 6.1.4 or 6.1.2.4 followed by two agitated and running rinses prior to step 6.1.5.

NOTE 2—If chromium compounds are used in the bright dip or alternatives in **Note 1**, additional steps will be required to ensure complete chromium removal from surfaces before any plating process.

NOTE 3—Additional information on procedures for cleaning of copper or copper alloys prior to electroplating may be found in Guide **B322**.

6.2 Precleaning—Solvent or solvent-alkali emulsion-soak cleaners can be used if the parts being electroplated can be rinsed easily and completely; otherwise, mild alkaline cleaners and vapor degreasing should be used.

6.3 Electrocleaning—To produce the chemically clean surface required for electroplating or subsequent coatings, an electrolytic cleaner may be used with the part as the anode or cathode. Anodic cleaning, particularly of brass, may cause slight tarnishing or etching if applied for a prolonged time (more than a few seconds) or at too high or too low an operating temperature. A contaminated cathodic cleaner may form a smut film on the work. The voltage at the source is usually 6 to 8 V. Separate solutions should be used for anodic and cathodic cleaning. When a part is properly cleaned, it will show a continuous liquid film upon removal from rinses after acid dip solutions.

NOTE 4—Proprietary cleaners which are used in accordance with the supplier's recommendations are preferred.

NOTE 5—The formula of a typical electrolytic cleaner composition is given in **Appendix X1**.

6.4 Tumble Cleaning—Tumble cleaning is an alternative process that can be used as a substitute for precleaning or electrocleaning depending on the parts being processed. A

typical tumble cleaner is listed in **Appendix X1**. Proprietary cleaners are available and are generally considered preferable.

6.5 Tarnish and Stain Removal, Deoxidizing, and Neutralizing:

6.5.1 Acid Dipping—After the work has been thoroughly cleaned and rinsed, it must be acidified to neutralize any residual alkali before it enters an electroplating bath. Thus, before nickel, copper, tin, chromium, and similar plating solutions, an acid dip is used. The most common dips used are sulfuric acid, 50 mL/L to 100 mL/L by volume, or hydrochloric acid, 100 mL/L to 200 mL/L by volume. Fluoboric acid, 50 mL/L to 100 mL/L by volume, can be used before fluoborate electroplating solutions. These solutions are maintained at room temperature. Leaded copper alloys form insoluble salts in either sulfuric or hydrochloric acid, and therefore should be pickled in fluoboric acid, 20 mL/L to 50 mL/L by volume, or nitric acid, 100 mL/L to 200 mL/L by volume.

6.5.2 Cyanide Dipping—After the work has been cleaned, acid pickled, or acid dipped, and thoroughly rinsed, it is sometimes immersed in a 15 to 45 g/L sodium cyanide solution to remove slight tarnish. This step is more common if the first electroplating solution also contains cyanide. (**Warning**—One should provide adequate rinsing before and after any cyanide-containing solution before going into an acid solution.)

NOTE 6—When processing parts containing lead as an alloy constituent, such as free-machining brass, care should be taken not to allow lead to accumulate in a cyanide solution beyond 50 mg/L as Pb.

6.5.3 Deoxidizing and Bright Dipping:

6.5.3.1 Deoxidizing is usually performed to activate the surface of the part by the removal of the oxide coating. Strong oxidizing solutions such as mixtures of sulfuric acid and hydrogen peroxide are used as pickling agents. Most of these compositions are proprietary.

6.5.3.2 Bright dipping is primarily used to improve the surface luster of the work. It also serves as a deoxidizing solution. While proprietary processes are available one non-proprietary composition which can produce good surface luster (not mirror brightness) is included in **Appendix X1**. The bright dipped parts should be rinsed thoroughly by immersion in several water rinses with constant agitation. A mild alkaline solution may be employed to neutralize residual acids before immersion in any cyanide-containing solution. An excess of hydrochloric acid in the bright dip composition must be avoided; otherwise, a dull finish will result.

7. Striking

7.1 Copper Strike—In order to prevent peeling, a copper strike is used before silver or nickel electroplating of leaded copper alloys and work that has been soft soldered. A nickel strike (see **Appendix X2**) may be used in addition to the copper strike before silver electroplating. A standard cyanide copper strike may be employed (see **Note 6**). All soldered surfaces and the basis metal must be completely covered with copper. This requires up to 1 min at 3 to 6 V.

7.2 Silver Strike—It is always necessary to apply a silver strike to the work before it enters a silver electroplating solution. The power source should be on and the electrical